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PTO/SÉ/64 (11-03)
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	PETITION FOR REVIVAL OF AN APPLICATION FOR PATENT	Docket Number (Optional)					
_	UNINTENTIONALLY UNDER 37 CFR 1.137(b)		F98ED0762				
:	First named inventor: Hiroki NAKAMURA						
	Application No.: 09/625,178	Art Unit: 2814					
	Filed: July 25, 2000	Examiner: MA	I, ANH D				
	Title: SEMICONDUCTOR DEVICE HAVING WIRING PAAND DUMMY PATTERNS COVERED WITH INSUI	ATTERNS LATING LAYER					
	Attention: Office of Petitions  Mail Stop Petition  Commissioner for Patents  P.O. Box 1450  Alexandria, VA 22313-1450  FAX: (703) 872-9306						
	NOTE: If information or assistance is needed in completing the Information at (703) 305-9282.	nis form, please cont	act Petitions				
	The above-identified application became abandoned for failure to file a timely and proper reply to a notice or action by the United States Patent and Trademark Office. The date of abandonment is the day after the expiration date of the period set for reply in the Office notice or action plus an extensions of time actually obtained.						
	APPLICANT HEREBY PETITIONS FOR REVIVAL C	F THIS APPLICATI	ON /				
•	NOTE: A grantable petition requires the following items:  (1) Petition fee;  (2) Reply and/or issue fee;  (3) Terminal disclaimer with disclaimer feerequired filed before June 8, 1995; and for all design appl (4) Statement that the entire delay was unintentional.  1. Petition fee  Small entity-fee \$ (37 CFR 1.17(m)). Applicant	lications; and I.					
	☑ Other than small entity - fee \$ <u>1,330</u> (37 CFR 1.17(m))						
	2. Reply and/or fee  A. The reply and/or fee to the above-noted Office action in the form ofAmendment has been filed previously on is enclosed herewith.  B. The issue fee of \$ or file of the previously on or file of the previously or	·	tify type of reply): 5 09625178				

[Page 1 of 2]

This collection of information is required by 37 CFR 1.137. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 1.0 hour to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. **SEND TO: Mail Stop Petition, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.** 

3. Terminal disclaimer with disclaimer fee							
☐ Since this utility/plant application was filed	on or after June 8, 1995, no terminal disclaimer is required.						
☐ A terminal disclaimer (and disclaimer fee (37 CFR 1.20(d)) of \$ for a small entity or \$ for other than a small entity) disclaiming the required period of time is enclosed herewith (see PTO/SB/63).							
filing of a grantable petition under 37 CFR 1.1 Trademark Office may require additional in	equired reply from the due date for the required reply until the 137(b) was unintentional. [NOTE. The United States Patent and information if there is a question as to whether either the inder 37 CFR 1.137(b) was unintentional (MPEP						
	y become public. Credit card information should not card information and authorization on PTO-2038.						
February 20, 2004	30/0						
Date	Signature						
Telephone	Tunichi MIMUDA						
Number: (202) 452-6190	Junichi MIMURA  Typed or printed name						
	1101 14th Street, N.W., Suite 555						
	Address Washington, D.C. 20005						
Enclosures: 🔀 Fee Payment	washington, b.c. 20005						
Reply	Address						
☐ Terminal Disclaimer Form							
	atements establishing unintentional delay						
✓ Other: <u>Fee Transmittal</u>	•						
	ILING OR TRANSMISSION [37 CFR 1.8(a)]						
I hereby certify that this correspondence is being	g:						
deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: <b>Mail Stop Petition</b> , Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.							
transmitted by facsimile on the date shown (703) 872-9306.	wn below to the United States Patent and Trademark Office at						
Date	Signature						
	Type or printed name of person signing certificate						

PTO/SB/17 (10-03)
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		ed to respond to a collection of information unless it displays a valid OMB control number.  Complete if Known			
FEE TRANSI	MIIAL	Application Number	09/625, 178		
for FY 2004  Effective 10/01/2003. Patent fees are subject to annual revision.		Filing Date	July 25, 2000		
		First Named Inventor	Hiroki NAKAMURA		
		Examiner Name	MAI, ANH D		
Applicant claims small entity status. Se		Art Unit	2814		
TOTAL AMOUNT OF PAYMENT (\$) 1,330		Attorney Docket No.	F98ED0762		
METHOD OF PAYMENT (check all that apply)		FEE CALCULATION (continued)			
Check Credit Card Money	Other None	3. ADDITIONAL FEES			

METHOD OF PAYMENT (check all that apply)	FEE CALCULATION (continued)					
Check Credit Card Money Other None	3. ADDITIONAL FEES					
Deposit Account:	<u>Large</u> Fee	Entity Fee	Small Fee	<u>Entity</u> Fee		
Deposit	Code	(\$)	Code	(\$)	Fee Description	Fee Paid
Account 50-0945	1051	130	2051		Surcharge – late filing fee or oath	
Number Deposit Otto A	1052	50	2052	25	Surcharge – late provisional filing fee or cover sheet.	
Account OKI America, Inc.	1053	130	1053	130	Non-English specification	
The Director is authorized to: (check all that apply)	1812	2,520	1812	2,520	For filing a request for ex parte reexamination	
Charge fee(s) indicated below Credit any overpayments	1804	920*	1804	920*	Requesting publication of SIR prior to Examiner action	
Charge any additional fee(s) or any underpayment of fee(s) Charge fee(s) indicated below, except for the filing fee to the above-identified deposit account.		1,840*	1805	1,840*	Requesting publication of SIR after Examiner action	
FEE CALCULATION	1251	110	2251	55	Extension for reply within first month	
1. BASIC FILING FEE	1252	420	2252	210	Extension for reply within second month	
Large Entity Small Entity	1253	950	2253	475	Extension for reply within third month	
Fee Fee Fee Fee <u>Fee Description</u> Fee Paid	1254	1,480	2254	740	Extension for reply within fourth month	
1001 770 2001 385 Utility filing fee	1255	2,010	2255	1,005	Extension for reply within fifth month	
1002 340 2002 170 Design filing fee	1401	330	2401	165	Notice of Appeal	
1003 530 2003 265 Plant filing fee	1402	330	2402	165	Filing a brief in support of an appeal	
1004 770 2004 385 Reissue filing fee	1403	290	2403	145	Request for oral hearing	
1005 160 2005 80 Provisional filing fee	1451	1,510	1451	1,510	Petition to institute a public use proceeding	
	1452	110	2452	55	Petition to revive - unavoidable	
SUBTOTAL (1) (\$)		1,330	2453	665	Petition to revive – unintentional	1,330
2. EXTRA CLAIM FEES FOR UTILITY AND REISSUE	1501	1,330	2501	665	Utility issue fee (or reissue)	
Extra Claims below Fee Paid	1502	480	2502	240	Design issue fee	
Total Claims 20**= x18 _ = 0	1503	640	2503	320	Plant issue fee	
Independent - 3** = 0 x 84 = 0	1460	130	1460	130	Petitions to the Commissioner	
Multiple Dependent 0 = 0	1807	50	1807	50	Processing fee under 37 CFR1.17(q)	
	1806	180	1806	180	Submission of Information Disclosure Stmt	
Large Entity Small Entity  Fee Fee Fee Fee  Code (\$) Fee Description	8021	40	8021	40	Recording each patent assignment per property (times number of properties)	
1202 18 2202 9 Claims in excess of 20	1809	770	2809	385	Filing a submission after final rejection (37 CFR 1.129(a))	
1201 86 2201 43 Independent claims in excess of 3 1203 290 2203 145 Multiple dependent claim. if not paid 1204 86 2204 43 **Reissue independent claims	1810	770	2810	385	For each additional invention to be	
over original patent	4004	77.	0004		examined (37 CFR 1.129(b))	
1205 18 2205 9 **Reissue claims in excess of 20 and over original patent	1801	770	2801		Request for Continued Examination (RCE)	
and over original patent	1802	900	1802	900	Request for expedited examination of a design application	
SUBTOTAL (2) (\$)	Other fee (specify)					
**or number previously paid, if greater; For Reissues, see above	*Reduce	d by Ba	sic Filin	g Fee P	aid SUBTOTAL (3) (\$)	1,330

SUBMITTED BY		Complete (if applicable)			
Name (Print/Type)	Junichi MIMURA	Registration No. (Attorney/Agent)	40,351	Telephone	(202) 452-6190
Signature	1	2		Date	February 20, 2004

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2814 Examiner: MAI, ANH D

In Re PATENT APPLICATION Of:

Applicant

: Hiroki NAKAMURA

Serial No.

: 09/625,178

Filed

: July 25, 2000

For

: SEMICONDUCTOR DEVICE HAVING

WIRING PATTERNS AND DUMMY PATTERNS COVERED WITH

**INSULATING LAYER** 

Attorney Ref. : F98ED0762

**AMENDMENT** 

February 20, 2004

**Commissioner for Patents** P. O. Box 1450 Alexandria, VA 22313-1450

Sir:

This application is revived by a Petition For Revival Of An Application For Patent Abandoned Unintentionally Under 37 CFR 1.137(b) filed herewith. Please amend the above-identified application as follows:

## **CLAIM AMENDMENT:**

Please amend claims 29, add new claims 34-37 and cancelled claims 1-20, 27, 28 and 30-33.

Claims 1-20 (cancelled).

Claim 21-26 (withdrawn).

Claim 27 and 28 (cancelled).

Claim 29 (currently amended): A semiconductor device, comprising:

a semiconductor substrate having a circuit area where an integrated circuit is formed and a peripheral area surrounding the circuit area;

wiring patterns formed on the substrate in the circuit area, the wiring pattern including a pad pattern;

a <u>first</u> dummy pattern which is formed of the same material as the wiring <u>patterns</u> pattern, formed in the peripheral area, <u>along an edge of the</u> <u>semiconductor substrate the dummy pattern encompassing the circuit area;</u>

a second dummy pattern, which is formed of the same material as the wiring patterns, and connected to the first dummy pattern formed in the peripheral area, the second dummy pattern encompassing a part of the circuit area;

a <u>second</u> first insulating layer formed over the wiring patterns and the <u>first</u> and <u>second</u> dummy <u>patterns</u> pattern, an edge of the first insulating layer being located on the pad pattern, which is adjacent the dummy pattern; and

a <u>first second</u> insulating layer formed above the semiconductor substrate, the <u>first second</u> insulating layer being formed <u>over the wiring patterns and the second insulating layer being formed outside the <u>first and second</u> dummy <u>patterns</u> <u>pattern</u> but not being formed over the <u>first and second</u> dummy <u>patterns</u> <u>pattern</u>.</u>

Claims 30-33 (canceled).

Claim 33 (new): A semiconductor device as claimed in claim 29, wherein the first insulating layer has a moisture absorbable characteristic.

Claim 35 (new): A semiconductor device as claimed in claim 29, wherein the first insulating layer is an SOG layer.

Claim 36 (new): A semiconductor device as claimed in claim 29, wherein the first dummy pattern has a width, which is fixed by a concentration of solid content of the insulating layer.

Claim 37 (new): A semiconductor device as claimed in claim 29, further comprising a third insulating layer I formed on the substrate, the first insulating layer being located between the second insulating layer and the third insulating layer.

## **REMARKS**

This application is revived by a Petition For Revival Of An Application For Patent Abandoned Unintentionally Under 37 CFR 1.137(b) filed herewith, and the Examiner's Office Action May 12, 2003 has been received and carefully reviewed. Claim 29 has been amended, claims 21-26 have been withdrawn from consideration, claims 1-20, 27, 28 and 30-33 have been cancelled, and claim 34-37 have been added. Therefore, claims 29 and 34-37 are pending in this application. For at least the following reasons, it is respectfully submitted that this application is in condition for allowance.

In the Action, Claims 16-20, 29 and 31-33 are rejected under 35 U.S.C. 112, second paragraph as failing to set forth the subject matter which Applicant regards as his invention. Claims 16-20, and 31-33 have been cancelled. Thus, the rejection under 35 U.S.C. 112, second paragraph applied to these claims should be withdrawn.

As to claim 29, the examiner asserts that a peripheral area surrounding the circuit area; wiring patterns formed on the substrate in the circuit area, the wiring pattern including a pad pattern", and further asserts that however, the pad pattern is formed between the dummy patterns 600a and 600b. Therefore, the pad pattern is formed within the peripheral area. Thus, claim 29 is contradicting itself indefinite. Applicant disagrees with the following reasons.

Claim 29 is drafted mainly to cover the third embodiment, which is illustrated in Fig. 7A and 7B. First, according to Fig. 7B and the specification on page 14, lines 15-16, it is clearly disclosed that a bonding pad 601 is formed in a circuit area. Second, it is not necessary to interpret that a circuit area is a single

area. The examiner asserts that the term "peripheral" means "outer part". However, it shall not be interpreted so restrictively. The term "peripheral area" means an area on the periphery of circuit area, which includes "outer part". Thus, the circuit area could be divided into some by a peripheral area, and it is actually done in the third embodiment. In the third embodiment, the bonding pad 601 is formed in the circuit area, and the first and fourth dummy patterns 600b, 600a are formed in the puerperal area. Thus, the circuit area is divided by the pattern 600a. Thus, there is no inconsistency between claims and disclosure of the invention. In addition, ab analysis of the intrinsic evidence alone will resolve any ambiguity in a disputed claim term. In such circumstances, it is improper to relay on extrinsic evidence. Vitronics Corp. v. Conceptronic, Inc, 90 F.3d 1576 (Fed.Cir.1996). Further, [A] patentee is free to be his own lexicographer. Markman v. Westview Instruments, Inc. 53 F.3d 967,980 (Fed.Cir.1995). Moreover, if intrinsic evidence clearly shows the meaning of the term, and if the meaning disclosed in the specification is conflict with the extrinsic evidence, then, an inconsistent dictionary definition mist be rejected. Texas Digital Systems, Inc. v. Telegenix, Inc. 308 F.3d 1193, 1204

Nevertheless, in order to make the claim limitation clear, claim 29 is amended to changed a dummy pattern to a first dummy pattern, which corresponds to a dummy pattern 600b, and to add new limitation "a second dummy pattern", which corresponds to a dummy pattern 600a.

Applicant believes that the rejection to claim 29 under 35 U.S.C. 112, second paragraph is dissolved by above-mentioned explanation and by amending claim 29, and thus, the rejection to claim 29 is no longer applicable.

In the Action, claims 1-3, 27-33 are provisionally rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claim 27-41 of copending Application No. 10/128, 244. Since claims 1-3, 27, 28 and 30-33 have been cancelled, and as to claim 29, terminal disclaimer has been filed on September 8, 2003, obviousness-type double patenting is no longer applicable.

In the Action, claims 1-4, 11-15, 27, 28 and 30 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamaha et al. in view of Hosoda et al. Since claims 1-4, 11-15, 27, 28 and 30 have been cancelled, the rejection under 35 U.S.C. 103(a) applied to these claims should be withdrawn.

As to <u>Product by process limitation</u>, the issue is whether the limitation "width is determined by the concentration of solid content of the SOG layer" is a process limitation or not. Newly added claim 32 has a limitation, which is similar to cancelled claims 3, 9, 14 and 19. Applicant understands this is not a process limitation because this limitation simply indicates a functional linkage between the width and the concentration of solid content of the SOG layer. Anyway, since claim 32 having such a limitation described above is a dependent claim, which depend form allowable independent claim 29, claim 32 is patentable.

In the Action, claims 5, 6, and 8-10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamaha et al., Hosoda et al., and further in view of

Domae et al. Since claims 5, 6, and 8-10 have been cancelled, the rejection under 35 U.S.C. 103(a) applied to these claims should be withdrawn.

It is noted that this Amendment has been prepared using the requested new format. If there are any irregularities in this format, it would be greatly appreciated if Applicant's Counsel would be so advised

In view of the foregoing, the application is deemed to be in condition for allowance and such is earnestly solicited. Should any fee be needed, please charge it to our Account No. 50-0945 and notify us accordingly.

Examination of the application is respectfully requested.

Respectfully submitted,

Junichi MIMURA

(Registration No.40,351)

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Date: February 20, 2004